# **ON Semiconductor**

# Is Now



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# **Low Noise Transistor**

# **PNP Silicon**

## **Features**

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V <sub>CEO</sub>	-50	Vdc
Collector - Base Voltage	V <sub>CBO</sub>	-50	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-3.0	Vdc
Collector Current – Continuous	Ic	-50	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, (Note 1) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

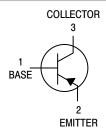
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1.  $FR-5 = 1.0 \times 0.75 \times 0.062$  in.
- 2. Alumina =  $0.4 \times 0.3 \times 0.024$  in. 99.5% alumina.



# ON Semiconductor®

#### www.onsemi.com





SOT-23 (TO-236) CASE 318 STYLE 6

#### **MARKING DIAGRAM**



2Q = Device Code

M = Date Code\*■ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MMBT5087LT1G,	SOT-23	3,000 / Tape &
NSVMMBT5087LT1G	(Pb-Free)	Reel
MMBT5087LT3G,	SOT-23	10,000 / Tape &
NSVMMBT5087LT3G	(Pb-Free)	Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	<u>.</u>		•	•
Collector–Emitter Breakdown Voltage $(I_C = -1.0 \text{ mAdc}, I_B = 0)$	V <sub>(BR)CEO</sub>	-50	_	Vdc
Collector–Base Breakdown Voltage ( $I_C = -100 \mu Adc$ , $I_E = 0$ )	V <sub>(BR)CBO</sub>	-50	-	Vdc
Collector Cutoff Current $(V_{CB} = -10 \text{ Vdc}, I_E = 0)$ $(V_{CB} = -35 \text{ Vdc}, I_E = 0)$	I <sub>CBO</sub>	_ _	-10 -50	nAdc
ON CHARACTERISTICS	·			
DC Current Gain	h <sub>FE</sub>	250 250 250	800 - -	-
Collector–Emitter Saturation Voltage $(I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc})$	V <sub>CE(sat)</sub>	-	-0.3	Vdc
Base–Emitter Saturation Voltage $(I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc})$	V <sub>BE(sat)</sub>	-	0.85	Vdc
SMALL-SIGNAL CHARACTERISTICS		•	•	•
Current–Gain — Bandwidth Product ( $I_C$ = $-500~\mu Adc$ , $V_{CE}$ = $-5.0~Vdc$ , f = 20 MHz)	f <sub>T</sub>	40	_	MHz
Output Capacitance $(V_{CB} = -5.0 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$	C <sub>obo</sub>	-	4.0	pF
Small–Signal Current Gain ( $I_C = -1.0 \text{ mAdc}$ , $V_{CE} = -5.0 \text{ Vdc}$ , $f = 1.0 \text{ kHz}$ )	h <sub>fe</sub>	250	900	-
Noise Figure $ \begin{array}{l} \text{(I}_C = -20 \text{ mAdc, V}_{CE} = -5.0 \text{ Vdc, R}_S = 10 \text{ k}\Omega, f = 1.0 \text{ kHz)} \\ \text{(I}_C = -100 \mu\text{Adc, V}_{CE} = -5.0 \text{ Vdc, R}_S = 3.0 \text{ k}\Omega, f = 1.0 \text{ kHz)} \end{array} $	NF	- -	2.0 2.0	dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **TYPICAL NOISE CHARACTERISTICS**

 $(V_{CE} = -5.0 \text{ Vdc}, T_A = 25^{\circ}C)$ 

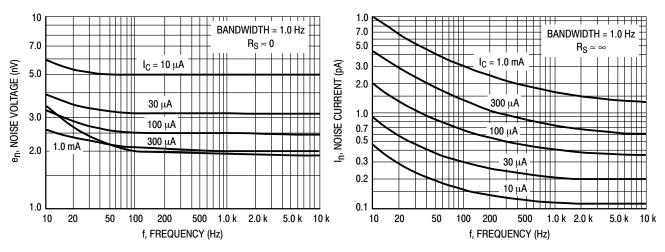


Figure 1. Noise Voltage

Figure 2. Noise Current

#### **NOISE FIGURE CONTOURS**

 $(V_{CE} = -5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C})$ 

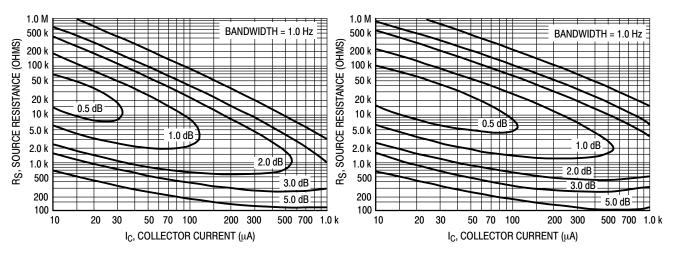


Figure 3. Narrow Band, 100 Hz

1.0 M 500 k 10 Hz to 15.7 kHz RS, SOURCE RESISTANCE (OHMS) 200 k 100 k 50 k 20 k 10 k 5.0 k 2.0 k 1.0 dB 1.0 k 2.0 dB 500 200 5.0 dB 100 20 30 500 700 1.0 k 50 70 100 200 300 10

 $I_C$ , COLLECTOR CURRENT ( $\mu A$ ) Figure 5. Wideband

Figure 4. Narrow Band, 1.0 kHz

Noise Figure is Defined as:

NF = 
$$20 \log_{10} \left[ \frac{e_n^2 + 4KTR_S + I_n^2 R_S^2}{4KTR_S} \right]^{1/2}$$

e<sub>n</sub> = Noise Voltage of the Transistor referred to the input. (Figure 3)

In = Noise Current of the Transistor referred to the input. (Figure 4)

 $K = Boltzman's Constant (1.38 x 10^{-23} j/°K)$ 

T = Temperature of the Source Resistance (°K)

R<sub>S</sub> = Source Resistance (Ohms)

## TYPICAL STATIC CHARACTERISTICS

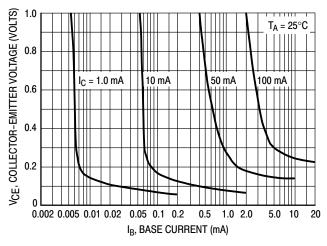
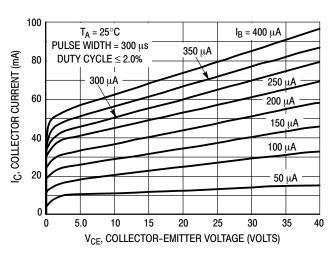


Figure 6. Collector Saturation Region



**Figure 7. Collector Characteristics** 

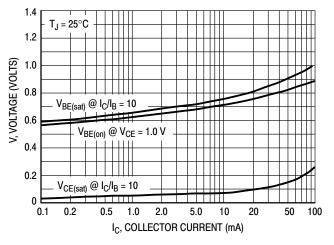
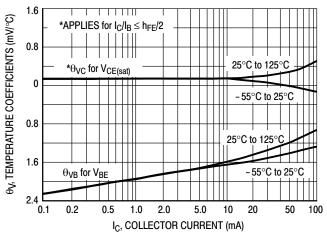
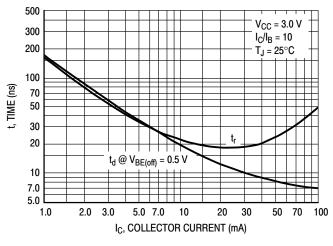


Figure 8. "On" Voltages



**Figure 9. Temperature Coefficients** 

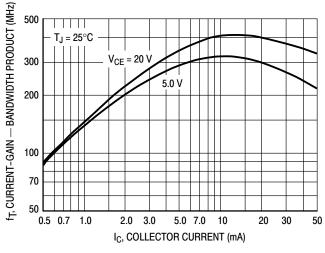
## TYPICAL DYNAMIC CHARACTERISTICS



1000  $V_{CC} = -3.0 \text{ V}$  $I_C/I_B = 10$ 700 500  $I_{B1} = I_{B2}$ 300  $T_J = 25^{\circ}C$ 200 t, TIME (ns) 100 70 50 30 20 10 -2.0 -3.0 -5.0 -7.0 -10 -20 -30 -50 -70 -100 -1.0 I<sub>C</sub>, COLLECTOR CURRENT (mA)

Figure 10. Turn-On Time

Figure 11. Turn-Off Time



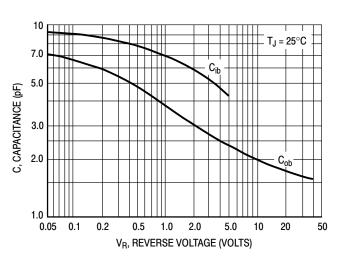


Figure 12. Current-Gain — Bandwidth Product

Figure 13. Capacitance

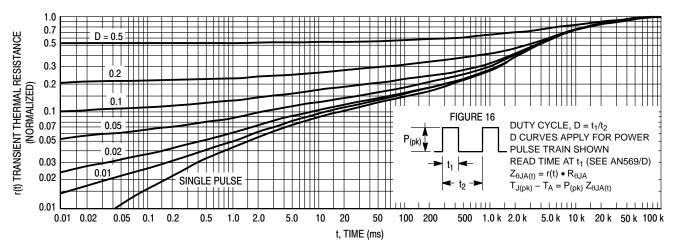


Figure 14. Thermal Response

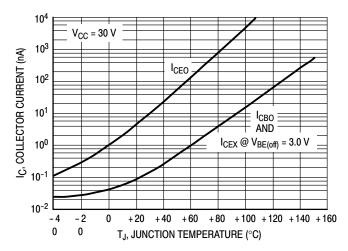


Figure 15. Typical Collector Leakage Current

#### **DESIGN NOTE: USE OF THERMAL RESPONSE DATA**

A train of periodical power pulses can be represented by the model as shown in Figure 16. Using the model and the device thermal response the normalized effective transient thermal resistance of Figure 14 was calculated for various duty cycles.

To find  $Z_{\theta JA(t)}$ , multiply the value obtained from Figure 14 by the steady state value  $R_{\theta JA}$ .

## Example:

Dissipating 2.0 watts peak under the following conditions:  $t_1=1.0 \text{ ms},\, t_2=5.0 \text{ ms} \ (D=0.2)$ 

Using Figure 14 at a pulse width of 1.0 ms and D = 0.2, the reading of r(t) is 0.22.

The peak rise in junction temperature is therefore

$$\Delta T = r(t) \times P_{(pk)} \times R_{\theta JA} = 0.22 \times 2.0 \times 200 = 88^{\circ}C.$$

For more information, see ON Semiconductor Application Note AN569/D, available from the Literature Distribution Center or on our website at **www.onsemi.com**.

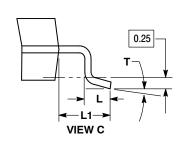


SOT-23 (TO-236) CASE 318-08 **ISSUE AS** 

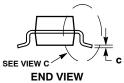
**DATE 30 JAN 2018** 

# SCALE 4:1 D - 3X b

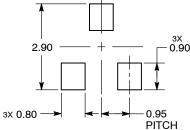
**TOP VIEW** 







#### **RECOMMENDED SOLDERING FOOTPRINT**



DIMENSIONS: MILLIMETERS

3. ANODE

#### NOTES:

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
  MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	0°		10°	0°		10°

#### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE		
STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 10: PIN 1. DRAIN 2. SOURCE 3. GATE	STYLE 11: PIN 1. ANODE 2. CATHODE 3. CATHODE-ANODE	STYLE 12: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 13: PIN 1. SOURCE 2. DRAIN 3. GATE	STYLE 14: PIN 1. CATHODE 2. GATE 3. ANODE
STYLE 15: PIN 1. GATE 2. CATHODE 3. ANODE	STYLE 16: PIN 1. ANODE 2. CATHODE 3. CATHODE	STYLE 17: PIN 1. NO CONNECTION 2. ANODE 3. CATHODE	STYLE 18: PIN 1. NO CONNECTION 2. CATHODE 3. ANODE	STYLE 19: PIN 1. CATHODE 2. ANODE 3. CATHODE-ANODE	STYLE 20: PIN 1. CATHODE 2. ANODE 3. GATE
STYLE 21: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT	STYLE 23: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 24: PIN 1. GATE 2. DRAIN 3. SOURCE	STYLE 25: PIN 1. ANODE 2. CATHODE 3. GATE	STYLE 26: PIN 1. CATHODE 2. ANODE 3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE				

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